AeroBase Group

View Online at https://aerobasegroup.com/nsn/5910-01-369-2714

# Body Style:

Chip type

**Reliability Indicator:** 

Established

### **Reliability Failure Rate Level In Percent:**

0.001

#### **Terminal Length:**

0.5 millimeters

#### **Body Length:**

2.0 millimeters

#### **Body Width:**

1.3 millimeters

#### **Body Height:**

1.3 millimeters

#### Schematic Diagram Designator:

No common or grounded electrode (s)

### Insulation Resistance At Maximum Operating Temp:

10000.0 megohms

### **Capacitance Value Per Section:**

5.600 picofarads single section

### Nonderated Operating Temp:

Between -55.0 degrees celsius and 125.0 degrees celsius

### Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:

0.0 single section

### Nonderated Continuous Voltage Rating And Type Per Section:

100.0 dc single section

# Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:

-30.0/+30.0 single section

# **Tolerance Range Per Section:**

-0.10/+0.10 picofarads single section

## Case Material:

Ceramic

# Insulation Resistance At Reference Temp:

100000.0 megohms

# Dissipation Factor At Reference Tempurature In Percent:

0.150

### **Terminal Surface Treatment:**

Solder

### **Test Data Document:**

81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

## Terminal Type And Quantity:

2 bonding pad



**Specification Data:** 

81349-mil-c-55681/7 government specification

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fiig:

A010b0